

LIST OF REFERENCES CITED BY APPLICANT (Use several sheets if necessary)				ATTY DOCKET NO. 060937-0140-US		APPLICATION NO.	
				APPLICANT Wai Mun LEE et al.			
				FILING DATE June 6, 2002		GROUP 1746	

**U.S. PATENT DOCUMENTS**

*EXAMINER INITIAL		DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE IF APPROPRIATE
	A01	4,617,251	10/1986	Sizensky			
	A02	5,997,658	12/1999	Peters et al.			
	A03	6,372,050	04/2002	Honda et al.			
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							YES	NO
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	B02	2001077063	03/2001	Japan (Abstract Only)				
	B03	10321569	12/1998	Japan (Abstract Only)				
	B04							
	B05							

OTHER REFERENCES (Including Author, Title, Date, Pertinent Pages, Etc.)		
	C01	
	C02	
	C03	

EXAMINER 	DATE CONSIDERED 6/20/05
*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.	